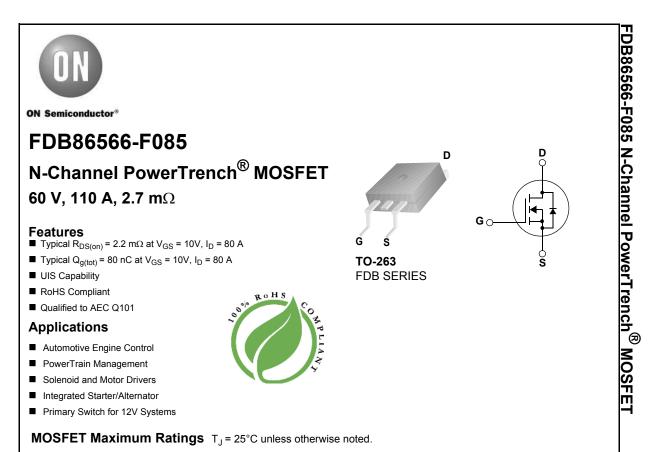
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| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|---|-----------------------|--------------|-------|--|
| V _{DSS} | Drain-to-Source Voltage | | 60 | V | |
| V _{GS} | Gate-to-Source Voltage | | ±20 | V | |
| | Drain Current - Continuous (V _{GS} =10) (Note 1) | T _C =25°C | 110 | • | |
| I _D | Pulsed Drain Current | T _C = 25°C | See Figure 4 | Α | |
| E _{AS} | Single Pulse Avalanche Energy | (Note 2) | 193 | mJ | |
| D | Power Dissipation | | 176 | W | |
| P _D | Derate Above 25°C | | 1.2 | W/ºC | |
| T _J , T _{STG} | Operating and Storage Temperature | | -55 to + 175 | °C | |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 0.85 | °C/W | |
| $R_{\theta JA}$ | Maximum Thermal Resistance, Junction to Ambient | (Note 3) | 43 | °C/W | |

Notes:

1: Current is limited by bondwire configuration.

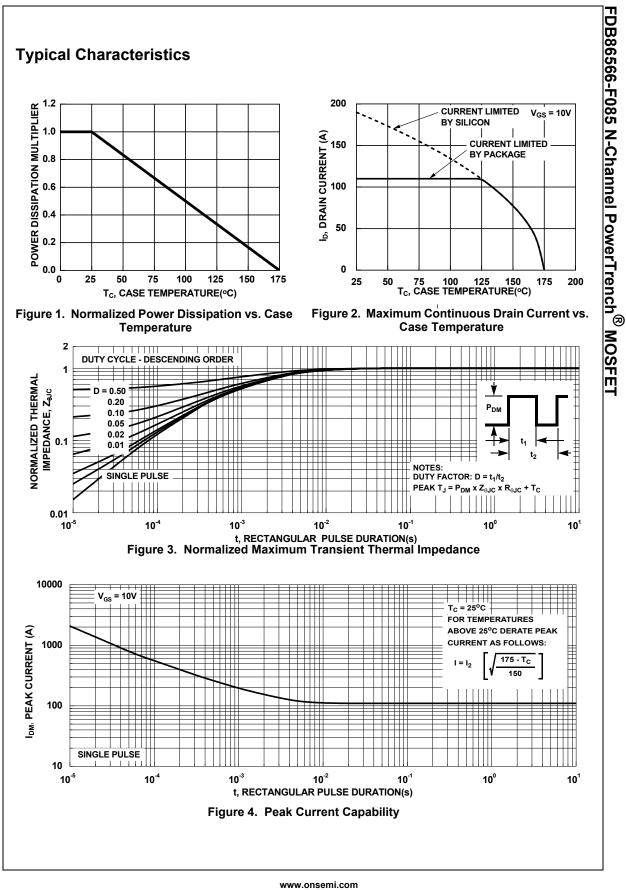
2: Starting $T_J = 25^{\circ}$ C, L = 50uH, $I_{AS} = 88$ A, $V_{DD} = 60$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

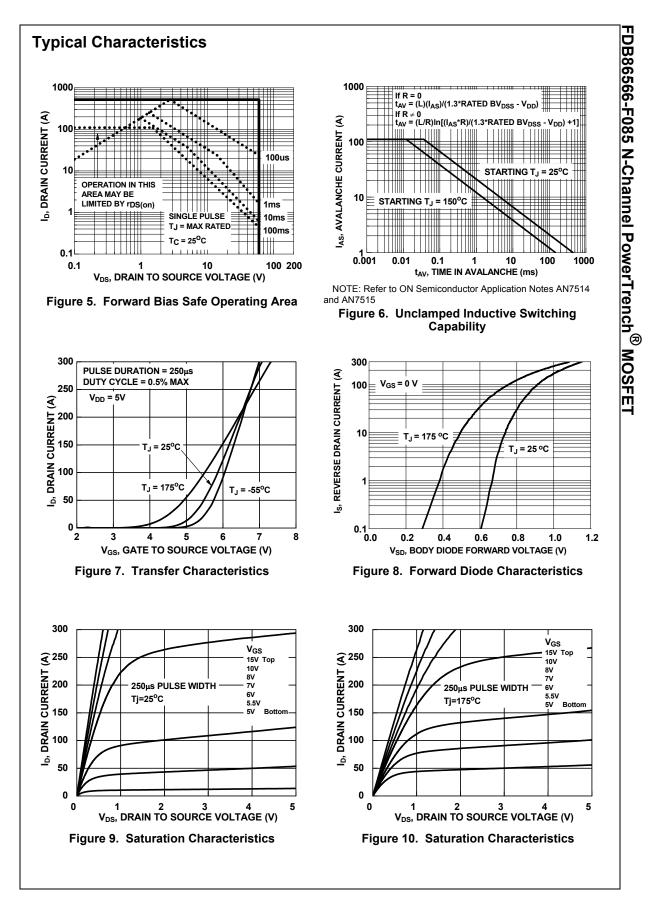
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

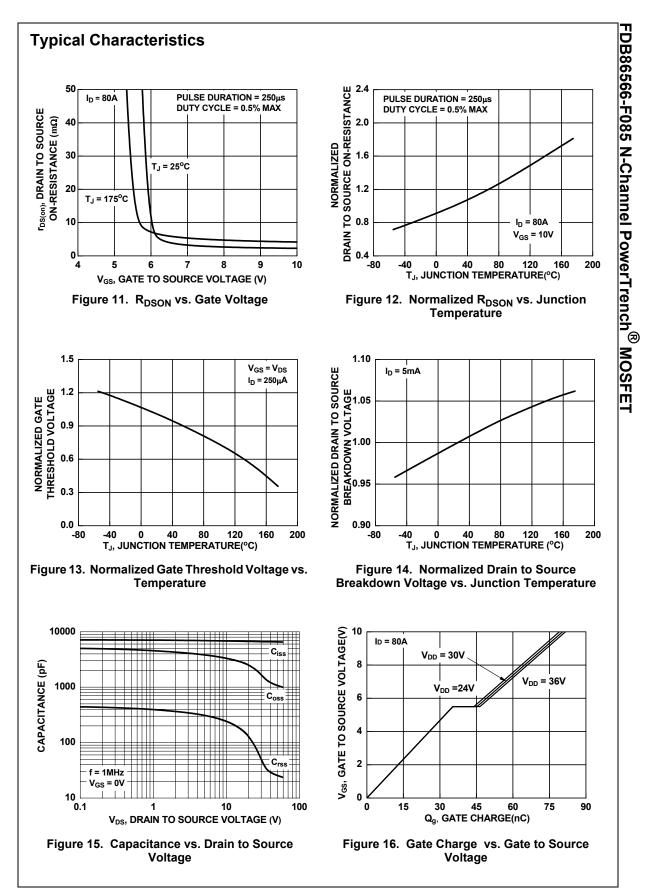
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|---------------|----------------|-----------|------------|-----------|
| FDB86566 | FDB86566-F085 | D2-PAK(TO-263) | 330mm | 24mm | 800 units |

| | Parameter | Test Conditions | | Min. | Тур. | Max. | Units |
|---|--|---|---|------|----------|--------------|---------------|
| Off Cha | aracteristics | | | | | | |
| B _{VDSS} | Drain-to-Source Breakdown Voltage | I _D = 250μA, V _{GS} = 0V | | 60 | - | - | V |
| I _{DSS} | Drain-to-Source Leakage Current | $V_{DS}=60V, T_{J}=25^{\circ}C$ $V_{GS}=0V T_{J}=175^{\circ}C$ (Note 4) | | - | - | 1 | μA mA |
| I _{GSS} | Gate-to-Source Leakage Current | $V_{GS} = \pm 20V$ $V_{GS} = \pm 20V$ | | - | - | ±100 | nA |
| On Cha | racteristics | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$ | | 2.0 | 3.2 | 4.0 | V |
| _ | Drain to Source On Resistance | I _D = 80A, | T _J = 25 ^o C | - | 2.2 | 2.7 | mΩ |
| R _{DS(on)} | | V _{GS} = 10V | $T_{J} = 175^{\circ}C$ (Note 4) | - | 4.1 | 5.0 | mΩ |
| Dynam | ic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | | | - | 6655 | - | pF |
| C _{oss} | Output Capacitance | $-V_{DS} = 30 V,$ | V _{GS} = 0V, | - | 1745 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | f = 1MHz | _ | - | 57 | - | pF |
| R _g | Gate Resistance | f = 1MHz | | - | 2.2 | - | Ω |
| Q _{g(ToT)} | Total Gate Charge at 10V | V _{GS} = 0 to 1 | 0V V _{DD} = 30V | - | 80 | 110 | nC |
| $Q_{g(th)}$ | Threshold Gate Charge | V _{GS} = 0 to 2 | | - | 12 | - | nC |
| Q _{gs} | Gate-to-Source Gate Charge | | 0 | - | 35 | - | nC |
| Q _{gd} | Gate-to-Drain "Miller" Charge | | | - | 10 | - | nC |
| Switchi | ng Characteristics | | | | 1 | 115 | 20 |
| + | Turn-On Delay | | - | - | - 36 | - | ns |
| | Tulli-Oli Delay | · · · · · · · · · · · · · · · · · · · | 904 | - | 52 | - | ns ns |
| t _{on} t _{d(on)} | Piso Timo | V_{DD} = 30V, I _D = 80A, V _{GS} = 10V, R _{GEN} = 6Ω | | - | 52 | - | ns |
| t _{d(on)} t _r | Rise Time | | | | 36 | | |
| t _{d(on)} t _r t _{d(off)} | Turn-Off Delay | | | - | 36 | - | - |
| t _{d(on)} t _r t _{d(off)} t _f | Turn-Off Delay Fall Time | | | - | 36 13 | - - 64 | ns |
| t _{d(on)} t _r t _{d(off)} t _f t _{off} | Turn-Off Delay Fall Time Turn-Off Time | | | | | - - 64 | - |
| t _{d(on)} t _r t _{d(off)} t _f t _{off} | Turn-Off Delay Fall Time | V _{GS} = 10V, | R _{GEN} = 6Ω | - | | 64 | ns ns |
| t _{d(on)} t _r t _{d(off)} t _f t _{off} Drain-S | Turn-Off Delay Fall Time Turn-Off Time cource Diode Characteristics | V _{GS} = 10V, | R _{GEN} = 6Ω _{GS} = 0V | - | | | ns |
| t _{d(on)} t _r t _{d(off)} t _f t _{off} Drain-S | Turn-Off Delay Fall Time Turn-Off Time | V _{GS} = 10V, | R _{GEN} = 6Ω _{GS} = 0V | - | | 64 | ns ns |
| t _{d(on)} t _r t _{d(off)} t _f t _{off} | Turn-Off Delay Fall Time Turn-Off Time cource Diode Characteristics | V _{GS} = 10V, | R _{GEN} = 6Ω _{GS} = 0V | - | - | 64 1.25 | ns ns V |





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